MC74AC08, MC74ACT08

Quad 2-Input AND Gate

Features

- Outputs Source/Sink 24 mA
- ′ACT08 Has TTL Compatible Inputs
- Pb−Free Packages are Available

ON Semiconductor®

http://onsemi.com

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Supply Voltage (Referenced to GND)	V_{CC}	−0.5 to +7.0	V
DC Input Voltage (Referenced to GND)	V_{in}	−0.5 to V_{CC} +0.5	V
DC Output Voltage (Referenced to GND)	V_{out}	−0.5 to V_{CC} +0.5	V
DC Input Current, per Pin	I_{in}	±20	mA
DC Output Sink/Source Current, per Pin	I_{out}	±50	mA
DC V_{CC} or GND Current per Output Pin	I_{CC}	±50	mA
Storage Temperature	T_{stg}	−65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

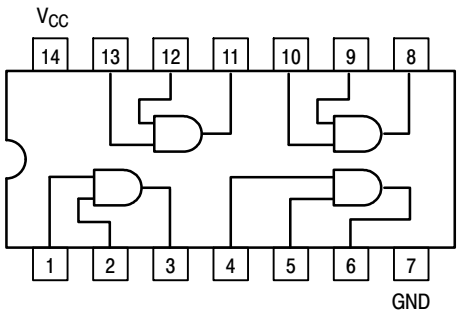
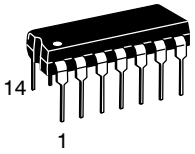
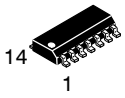


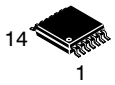
Figure 1. Pinout: 14−Lead Packages Conductors
(Top View)



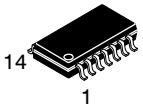
PDIP−14
N SUFFIX
CASE 646



SO−14
D SUFFIX
CASE 751A



TSSOP−14
DT SUFFIX
CASE 948G



SOEIAJ−14
M SUFFIX
CASE 965

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 5 of this data sheet.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Typ	Max	Unit
V_{CC}	Supply Voltage	′AC	2.0	5.0	6.0	V
		′ACT	4.5	5.0	5.5	
V_{in}, V_{out}	DC Input Voltage, Output Voltage (Ref. to GND)		0	–	V_{CC}	V
t_r, t_f	Input Rise and Fall Time (Note 1) ′AC Devices except Schmitt Inputs	V_{CC} @ 3.0 V	–	150	–	ns/V
		V_{CC} @ 4.5 V	–	40	–	
		V_{CC} @ 5.5 V	–	25	–	
t_r, t_f	Input Rise and Fall Time (Note 2) ′ACT Devices except Schmitt Inputs	V_{CC} @ 4.5 V	–	10	–	ns/V
		V_{CC} @ 5.5 V	–	8.0	–	
T_J	Junction Temperature (PDIP)		–	–	140	°C
T_A	Operating Ambient Temperature Range		−40	25	85	°C
I_{OH}	Output Current – High		–	–	−24	mA
I_{OL}	Output Current – Low		–	–	24	mA

1. V_{in} from 30% to 70% V_{CC}; see individual Data Sheets for devices that differ from the typical input rise and fall times.
2. V_{in} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

DC CHARACTERISTICS

Symbol	Parameter	Conditions	V_{CC} (V)	74AC T_A = +25°C Typ	74AC T_A = −40°C to +85°C Guaranteed Limits		Unit
V_{IH}	Minimum High Level Input Voltage	V_{OUT} = 0.1 V or V_{CC} − 0.1 V	3.0	1.5	2.1	2.1	V
			4.5	2.25	3.15	3.15	
			5.5	2.75	3.85	3.85	
V_{IL}	Maximum Low Level Input Voltage	V_{OUT} = 0.1 V or V_{CC} − 0.1 V	3.0	1.5	0.9	0.9	V
			4.5	2.25	1.35	1.35	
			5.5	2.75	1.65	1.65	
V_{OH}	Minimum High Level Output Voltage	I_{OUT} = −50 μA	3.0	2.99	2.9	2.9	V
			4.5	4.49	4.4	4.4	
			5.5	5.49	5.4	5.4	
		V_{IN} = V_{IL} or V_{IH} (Note 3)					V
		I_{OH} −12 mA	3.0	–	2.56	2.46	
		I_{OH} −24 mA	4.5	–	3.86	3.76	
		I_{OH} −24 mA	5.5	–	4.86	4.76	
V_{OL}	Maximum Low Level Output Voltage	V_{IN} = V_{IL} or V_{IH}(Note 3)					V
		I_{OL} 12 mA	3.0	–	0.36	0.44	
		I_{OL} 24 mA	4.5	–	0.36	0.44	
		I_{OL} 24 mA	5.5	–	0.36	0.44	
I_{IN}	Maximum Input Leakage Current	V_I = V_{CC}, GND	5.5	–	±0.1	±1.0	μA
I_{OLD}	Minimum Dynamic (Note 4) Output Current	V_{OLD} = 1.65 V Max	5.5	–	–	75	mA
I_{OHD}		V_{OHD} = 3.85 V Min	5.5	–	–	−75	mA
I_{CC}	Maximum Quiescent Supply Current	V_{IN} = V_{CC} or GND	5.5	–	4.0	40	μA

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

3. All outputs loaded; thresholds on input associated with output under test.
4. Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS (For Figures and Waveforms − See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

Symbol	Parameter	V_{CC} (V) (Note5)	74AC T_A = +25°C C_L = 50 pF			74AC T_A = −40°C to +85°C C_L = 50 pF		Unit	Fig. No.
			Min	Typ	Max	Min	Max		
t_{PLH}	Propagation Delay	3.3 5.0	1.5 1.5	7.5 5.5	9.5 7.5	1.0 1.0	10.0 8.5	ns	3−5
t_{PHL}	Propagation Delay	3.3 5.0	1.5 1.5	7.0 5.5	8.5 7.0	1.0 1.0	9.0 7.5	ns	3−5

5. Voltage Range 3.3 V is 3.3 V ±0.3 V.
   Voltage Range 5.0 V is 5.0 V ±0.5 V.

DC CHARACTERISTICS

Symbol	Parameter	Conditions	V_{CC} (V)	74ACT T_A = +25°C		74ACT T_A = −40°C to +85°C	Unit
				Typ	Guaranteed Limits		
V_{IH}	Minimum High Level Input Voltage	V_{OUT} = 0.1 V	4.5	1.5	2.0	2.0	V
		or V_{CC} − 0.1 V	5.5	1.5	2.0	2.0	
V_{IL}	Maximum Low Level Input Voltage	V_{OUT} = 0.1 V	4.5	1.5	0.8	0.8	V
		or V_{CC} − 0.1 V	5.5	1.5	0.8	0.8	
V_{OH}	Minimum High Level Output Voltage	I_{OUT} = −50 μA	4.5	4.49	4.4	4.4	V
			5.5	5.49	5.4	5.4	
		V_{IN} = V_{IL} or V_{IH} (Note 6)					V
		−24 mA	4.5	−	3.86	3.76	
		−24 mA	5.5	−	4.86	4.76	
V_{OL}	Maximum Low Level Output Voltage	I_{OUT} = 50 μA	4.5	0.001	0.1	0.1	V
			5.5	0.001	0.1	0.1	
		V_{IN} = V_{IL} or V_{IH} (Note 6)					V
		24 mA	4.5	−	0.36	0.44	
		24 mA	5.5	−	0.36	0.44	
I_{IN}	Maximum Input Leakage Current	V_I = V_{CC}, GND	5.5	−	±0.1	±1.0	μA
ΔI_{CCT}	Additional Max. I_{CC}/Input	V_I = V_{CC} − 2.1 V	5.5	0.6	−	1.5	mA
I_{OLD}	Minimum Dynamic (Note 7) Output Current	V_{OLD} = 1.65 V Max	5.5	−	−	75	mA
I_{OHD}		V_{OHD} = 3.85 V Min	5.5	−	−	−75	mA
I_{CC}	Maximum Quiescent Supply Current	V_{IN} = V_{CC} or GND	5.5	−	4.0	40	μA

6. All outputs loaded; thresholds on input associated with output under test.
7. Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS (For Figures and Waveforms − See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

Symbol	Parameter	V_{CC} (V) (Note 8)	74ACT T_A = +25°C, C_L = 50 pF			74ACT T_A = −40°C to +85°C, C_L = 50 pF		Unit	Fig. No.
			Min	Typ	Max	Min	Max		
t_{PLH}	Propagation Delay	5.0	1.0	–	9.0	1.0	10.0	ns	3–5
t_{PHL}	Propagation Delay	5.0	1.0	–	9.0	1.0	10.0	ns	3–5

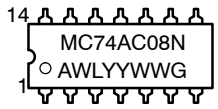
8. Voltage Range 5.0 V is 5.0 V ±0.5 V.

CAPACITANCE

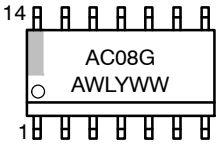
Symbol	Parameter	Test Conditions	Value Typ	Unit
C_{IN}	Input Capacitance	V_{CC} = 5.0 V	4.5	pF
C_{PD}	Power Dissipation Capacitance	V_{CC} = 5.0 V	20	pF

MARKING DIAGRAMS

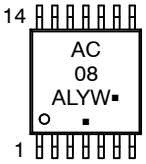
PDIP−14



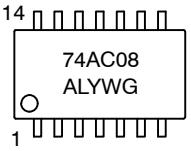
SOIC−14

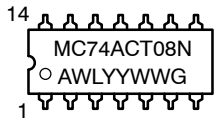


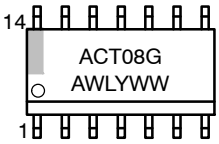
TSSOP−14

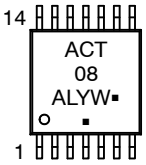


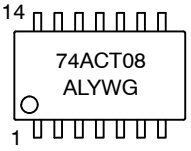
SOEIAJ−14











A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G or ▪ = Pb−free Package
(Note: Microdot may be in either location)

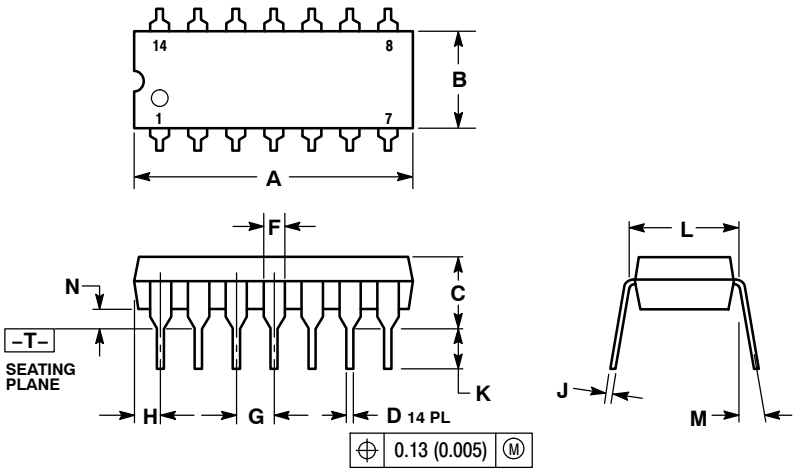
ORDERING INFORMATION

Device	Package	Shipping†
MC74AC08NG	PDIP−14 (Pb−Free)	25 Units / Rail
MC74AC08D	SOIC−14	55 Units / Rail
MC74AC08DG	SOIC−14 (Pb−Free)	
MC74AC08DR2	SOIC−14	2500 / Tape & Reel
MC74AC08DR2G	SOIC−14 (Pb−Free)	
MC74AC08DTR2	TSSOP−14*	
MC74AC08DTR2G	TSSOP−14*	
MC74AC08MEL	SOEIAJ−14	2000 / Tape & Reel
MC74AC08MELG	SOEIAJ−14 (Pb−Free)	
MC74ACT08N	PDIP−14	25 Units / Rail
MC74ACT08NG	PDIP−14 (Pb−Free)	
MC74ACT08D	SOIC−14	55 Units / Rail
MC74ACT08DG	SOIC−14 (Pb−Free)	
MC74ACT08DR2	SOIC−14	2500 / Tape & Reel
MC74ACT08DR2G	SOIC−14 (Pb−Free)	
MC74ACT08DR2GH	SOIC−14 (Pb−Free, Halide−Free)	
MC74ACT08DTR2	TSSOP−14*	
MC74ACT08DTR2G	TSSOP−14*	
MC74ACT08MELG	SOEIAJ−14 (Pb−Free)	2000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*This package is inherently Pb−Free.

PACKAGE DIMENSIONS

PDIP−14
CASE 646−06
ISSUE P

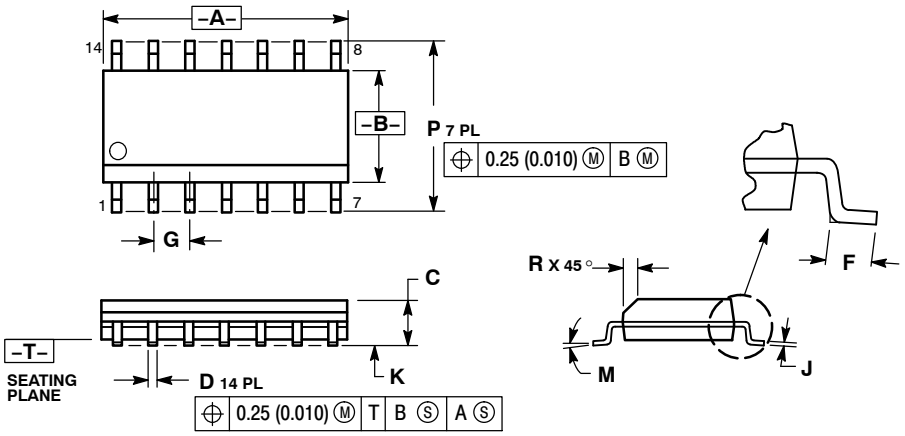


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.715	0.770	18.16	19.56
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.290	0.310	7.37	7.87
M	−−−	10 °	−−−	10 °
N	0.015	0.039	0.38	1.01

PACKAGE DIMENSIONS

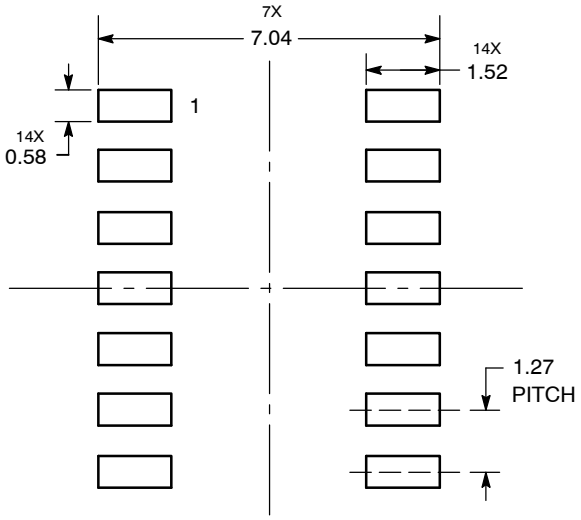
SOIC−14
CASE 751A−03
ISSUE J



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0 °	7 °	0 °	7 °
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

SOLDERING FOOTPRINT*

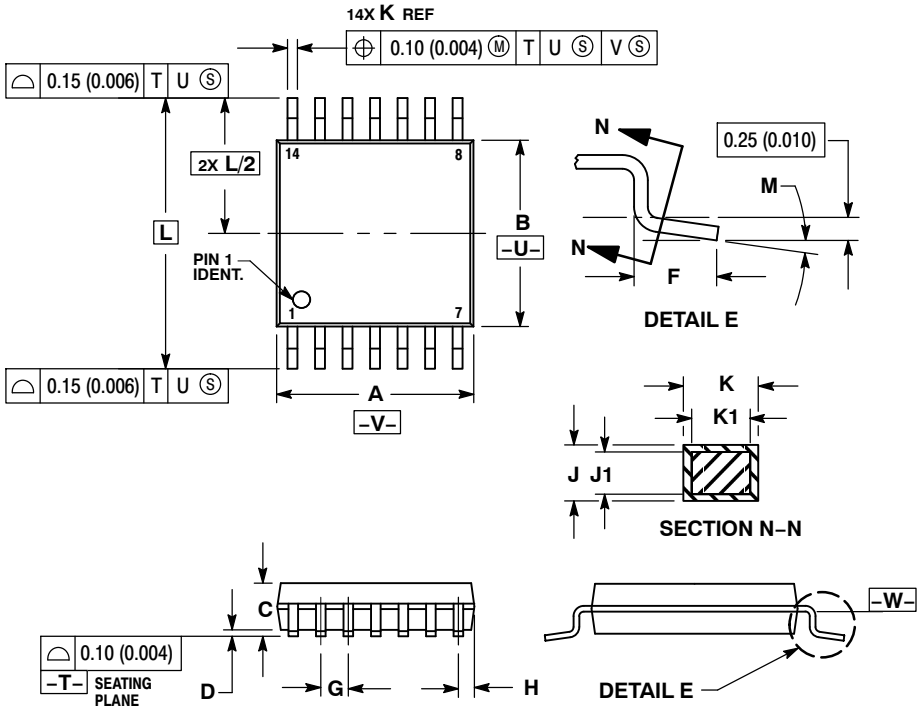


DIMENSIONS: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

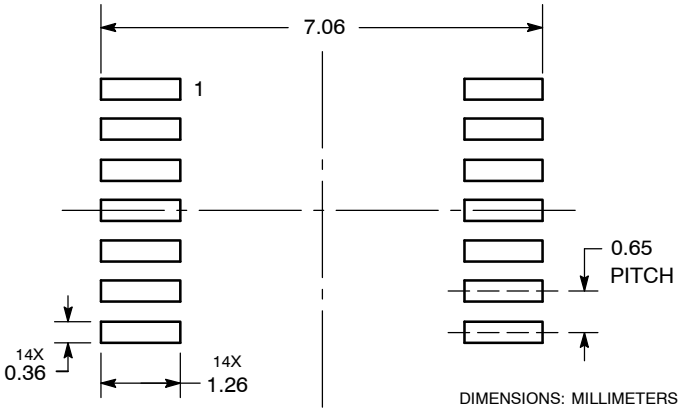
TSSOP−14
CASE 948G−01
ISSUE B



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE −W−.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0 °	8 °	0 °	8 °

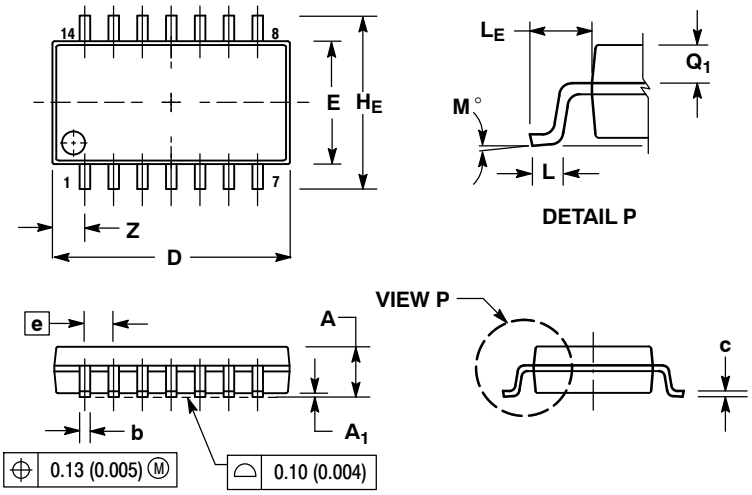
SOLDERING FOOTPRINT*



*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

SOEIAJ−14
CASE 965−01
ISSUE B



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A_1	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.10	0.20	0.004	0.008
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H_E	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L_E	1.10	1.50	0.043	0.059
M	0 °	10 °	0 °	10 °
Q_1	0.70	0.90	0.028	0.035
Z	---	1.42	---	0.056

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
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For additional information, please contact your local Sales Representative

MC74AC08/D

OCEAN CHIPS
Океан Электроники
Поставка электронных компонентов

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «**JONHON**», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «**FORSTAR**».

AVIC JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).

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